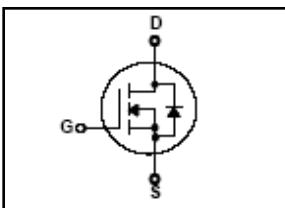


## HRS88N08K 80V N-Channel Trench MOSFET

### FEATURES

- Originative New Design
- Superior Avalanche Rugged Technology
- Excellent Switching Characteristics
- Unrivalled Gate Charge : 75nC (Typ.)
- Extended Safe Operating Area
- Lower  $R_{DS(ON)}$  : 7.4 mΩ (Typ.) @  $V_{GS}=10V$
- 100% Avalanche Tested

$BV_{DSS} = 80 V$   
 $R_{DS(on)\ typ} = 7.4m\Omega$   
 $I_D = 80 A$



### Absolute Maximum Ratings $T_C=25^\circ C$ unless otherwise specified

| Symbol         | Parameter   | Value       | Units |
|----------------|---|-------------|-------|
| $V_{DSS}$      | Drain-Source Voltage  | 80          | V     |
| $I_D$          | Drain Current – Continuous ( $T_C = 25^\circ C$ )                             | 80 *        | A     |
|                | Drain Current – Continuous ( $T_C = 100^\circ C$ )                            | 56 *        | A     |
| $I_{DM}$       | Drain Current – Pulsed (Note 1)   | 280 *       | A     |
| $V_{GS}$       | Gate-Source Voltage   | $\pm 25$    | V     |
| $E_{AS}$       | Single Pulsed Avalanche Energy (Note 2)                                       | 230         | mJ    |
| $E_{AR}$       | Repetitive Avalanche Energy (Note 1)  | 3.8         | mJ    |
| $P_D$          | Power Dissipation ( $T_C = 25^\circ C$ )                                      | 38          | W     |
|                | - Derate above $25^\circ C$   | 0.25        | W/°C  |
| $T_J, T_{STG}$ | Operating and Storage Temperature Range                                       | -55 to +175 | °C    |
| $T_L$          | Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds | 300         | °C    |

\* Drain current limited by maximum junction temperature

### Thermal Resistance Characteristics

| Symbol          | Parameter           | Typ. | Max. | Units |
|-----------------|---------------------|------|------|-------|
| $R_{\theta JC}$ | Junction-to-Case    | --   | 4.0  | °C/W  |
| $R_{\theta JA}$ | Junction-to-Ambient | --   | 62.5 |       |

**Electrical Characteristics**  $T_J=25^\circ\text{C}$  unless otherwise specified

| Symbol | Parameter | Test Conditions | Min | Typ | Max | Units |
|--------|-----------|-----------------|-----|-----|-----|-------|
|--------|-----------|-----------------|-----|-----|-----|-------|

**On Characteristics**

|                     |                                   |  |     |     |     |                  |
|---------------------|-----------------------------------|--|-----|-----|-----|------------------|
| $V_{GS}$            | Gate Threshold Voltage            | $V_{DS} = V_{GS}$ , $I_D = 250 \mu\text{A}$    | 2.2 | --  | 3.8 | V                |
| $R_{DS(\text{ON})}$ | Static Drain-Source On-Resistance | $V_{GS} = 10 \text{ V}$ , $I_D = 40 \text{ A}$ | --  | 7.4 | 8.8 | $\text{m}\Omega$ |
| $g_{FS}$            | Forward Transconductance          | $V_{DS} = 20$ , $I_D = 40 \text{ A}$           | --  | 80  | --  | S                |

**Off Characteristics**

|            |                                 |  |    |    |           |               |
|------------|---------------------------------|--|----|----|-----------|---------------|
| $BV_{DSS}$ | Drain-Source Breakdown Voltage  | $V_{GS} = 0 \text{ V}$ , $I_D = 250 \mu\text{A}$     | 80 | -- | --        | V             |
| $I_{DSS}$  | Zero Gate Voltage Drain Current | $V_{DS} = 64 \text{ V}$ , $V_{GS} = 0 \text{ V}$     | -- | -- | 1         | $\mu\text{A}$ |
|            |                                 | $V_{DS} = 64 \text{ V}$ , $T_J = 125^\circ\text{C}$  | -- | -- | 100       | $\mu\text{A}$ |
| $I_{GSS}$  | Gate-Body Leakage Current       | $V_{GS} = \pm 25 \text{ V}$ , $V_{DS} = 0 \text{ V}$ | -- | -- | $\pm 100$ | nA            |

**Dynamic Characteristics**

|           |                              |   |    |      |    |          |
|-----------|------------------------------|---|----|------|----|----------|
| $C_{iss}$ | Input Capacitance            | $V_{DS} = 25 \text{ V}$ , $V_{GS} = 0 \text{ V}$ ,<br>$f = 1.0 \text{ MHz}$ | -- | 3700 | -- | pF       |
| $C_{oss}$ | Output Capacitance           |   | -- | 270  | -- | pF       |
| $C_{rss}$ | Reverse Transfer Capacitance |   | -- | 240  | -- | pF       |
| $R_g$     | Gate Resistance              | $V_{GS} = 0 \text{ V}$ , $V_{DS} = 0 \text{ V}$ , $f = 1\text{MHz}$         | -- | 1.7  | -- | $\Omega$ |

**Switching Characteristics**

|              |                     |   |    |     |    |    |
|--------------|---------------------|---|----|-----|----|----|
| $t_{d(on)}$  | Turn-On Time        | $V_{DS} = 40 \text{ V}$ , $I_D = 30 \text{ A}$ ,<br>$R_G = 6 \Omega$        | -- | 60  | -- | ns |
| $t_r$        | Turn-On Rise Time   |   | -- | 60  | -- | ns |
| $t_{d(off)}$ | Turn-Off Delay Time |   | -- | 150 | -- | ns |
| $t_f$        | Turn-Off Fall Time  |   | -- | 50  | -- | ns |
| $Q_g$        | Total Gate Charge   | $V_{DS} = 64 \text{ V}$ , $I_D = 30 \text{ A}$ ,<br>$V_{GS} = 10 \text{ V}$ | -- | 75  | -- | nC |
| $Q_{gs}$     | Gate-Source Charge  |   | -- | 20  | -- | nC |
| $Q_{gd}$     | Gate-Drain Charge   |   | -- | 25  | -- | nC |

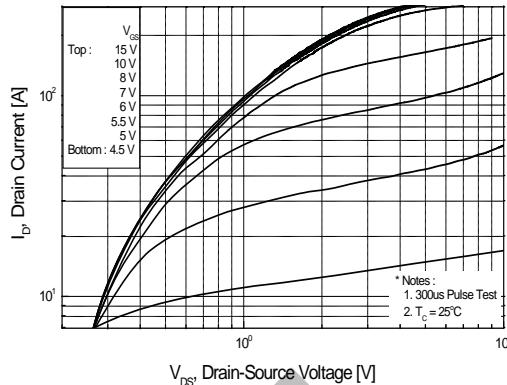
**Source-Drain Diode Maximum Ratings and Characteristics**

|          |   |  |    |     |     |    |
|----------|---|--|----|-----|-----|----|
| $I_S$    | Continuous Source-Drain Diode Forward Current | --   | -- | 80  | A   |    |
| $I_{SM}$ | Pulsed Source-Drain Diode Forward Current     | --   | -- | 280 |     |    |
| $V_{SD}$ | Source-Drain Diode Forward Voltage            | $I_S = 30 \text{ A}$ , $V_{GS} = 0 \text{ V}$  | -- | --  | 1.3 | V  |
| $trr$    | Reverse Recovery Time                         | $I_S = 30 \text{ A}$ , $V_{GS} = 0 \text{ V}$<br>$di_F/dt = 100 \text{ A}/\mu\text{s}$ | -- | 45  | --  | ns |
| $Qrr$    | Reverse Recovery Charge                       |  | -- | 65  | --  | nC |

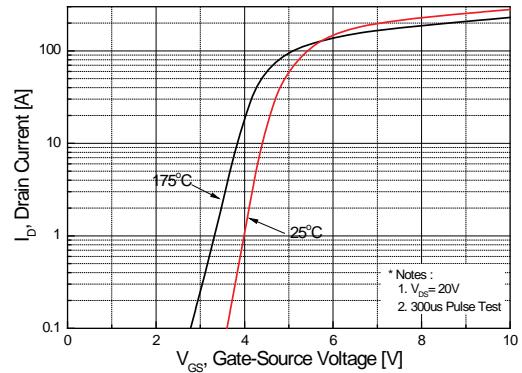
**Notes :**

- Repetitive Rating : Pulse width limited by maximum junction temperature
- $L=0.5\text{mH}$ ,  $I_{AS}=25\text{A}$ ,  $V_{DD}=25\text{V}$ ,  $R_G=25\Omega$ , Starting  $T_J=25^\circ\text{C}$

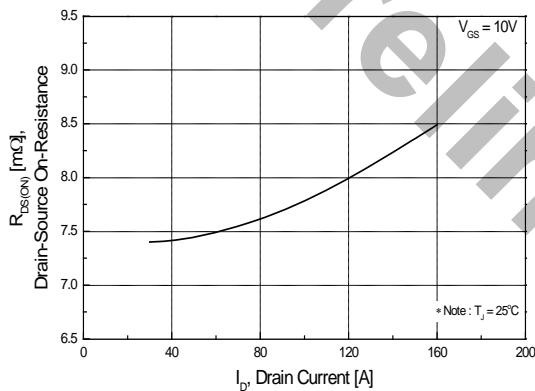
## Typical Characteristics



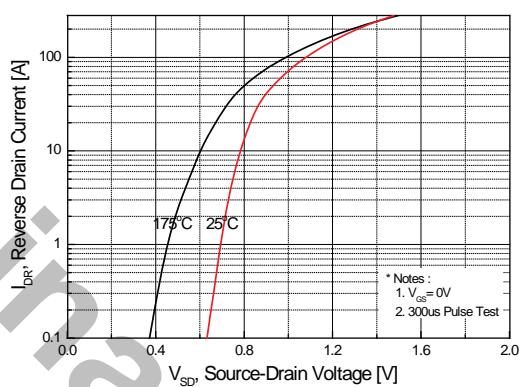
**Figure 1. On Region Characteristics**



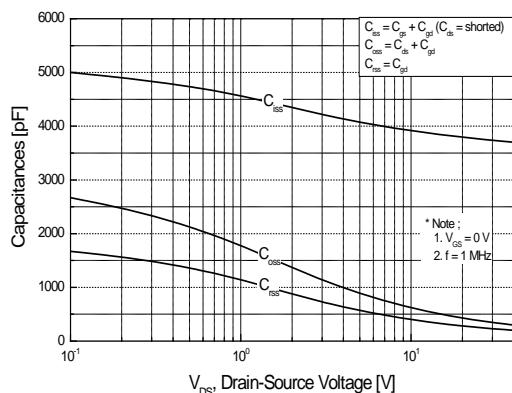
**Figure 2. Transfer Characteristics**



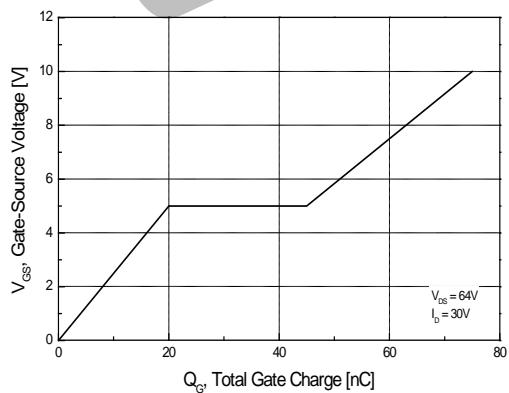
**Figure 3. On Resistance Variation vs. Drain Current and Gate Voltage**



**Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature**



**Figure 5. Capacitance Characteristics**



**Figure 6. Gate Charge Characteristics**

## Typical Characteristics (continued)

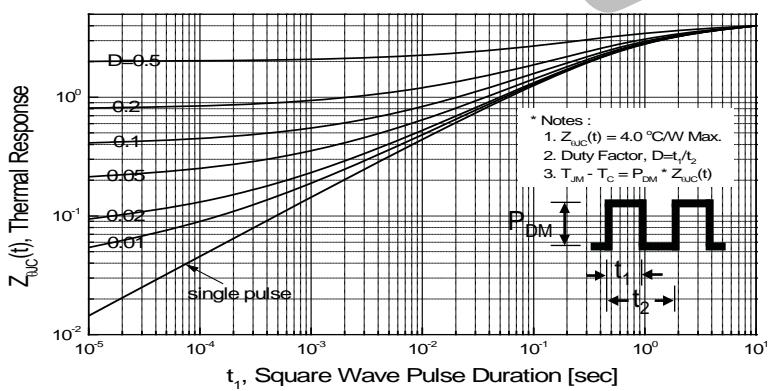
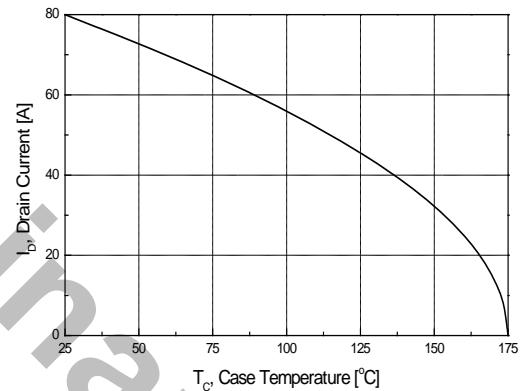
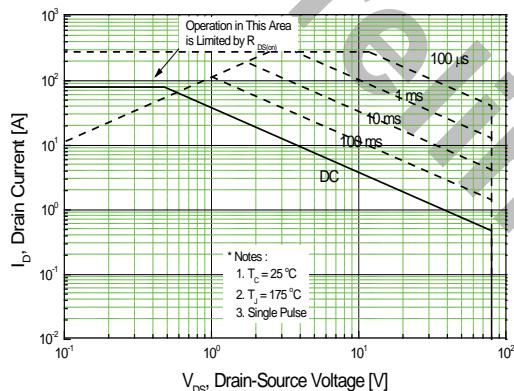
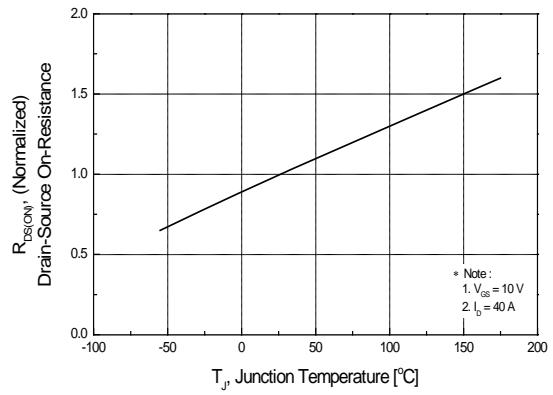
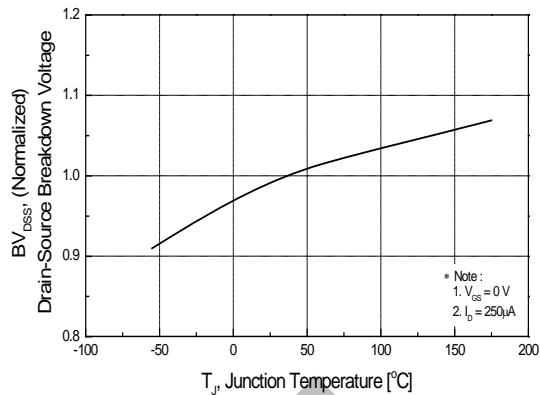


Fig 12. Gate Charge Test Circuit &amp; Waveform

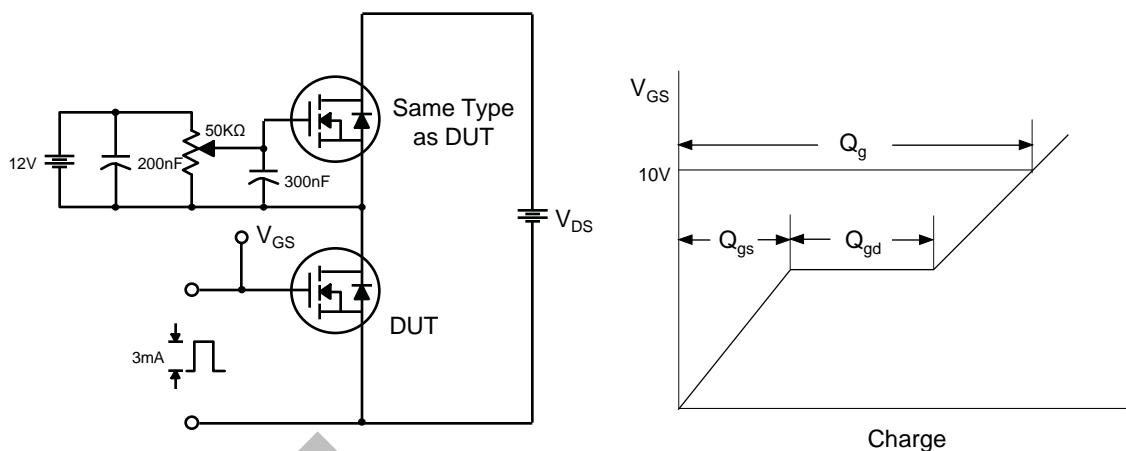


Fig 13. Resistive Switching Test Circuit &amp; Waveforms

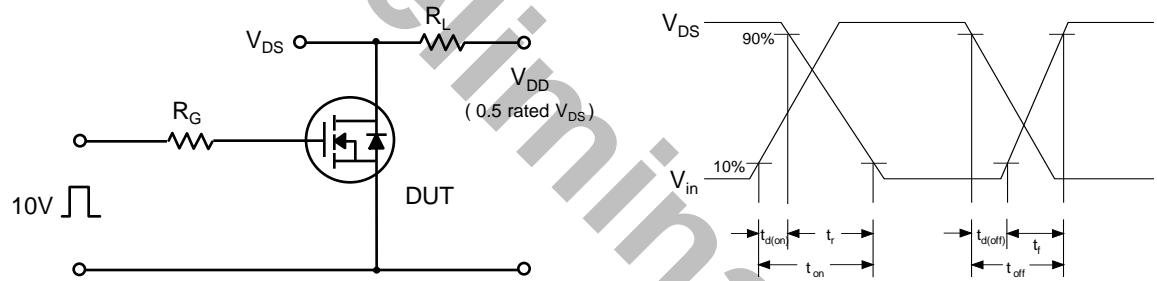


Fig 14. Unclamped Inductive Switching Test Circuit &amp; Waveforms

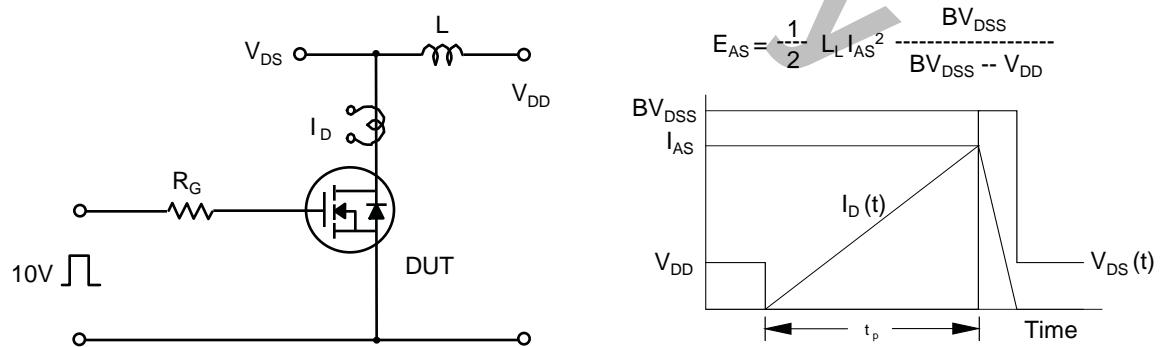
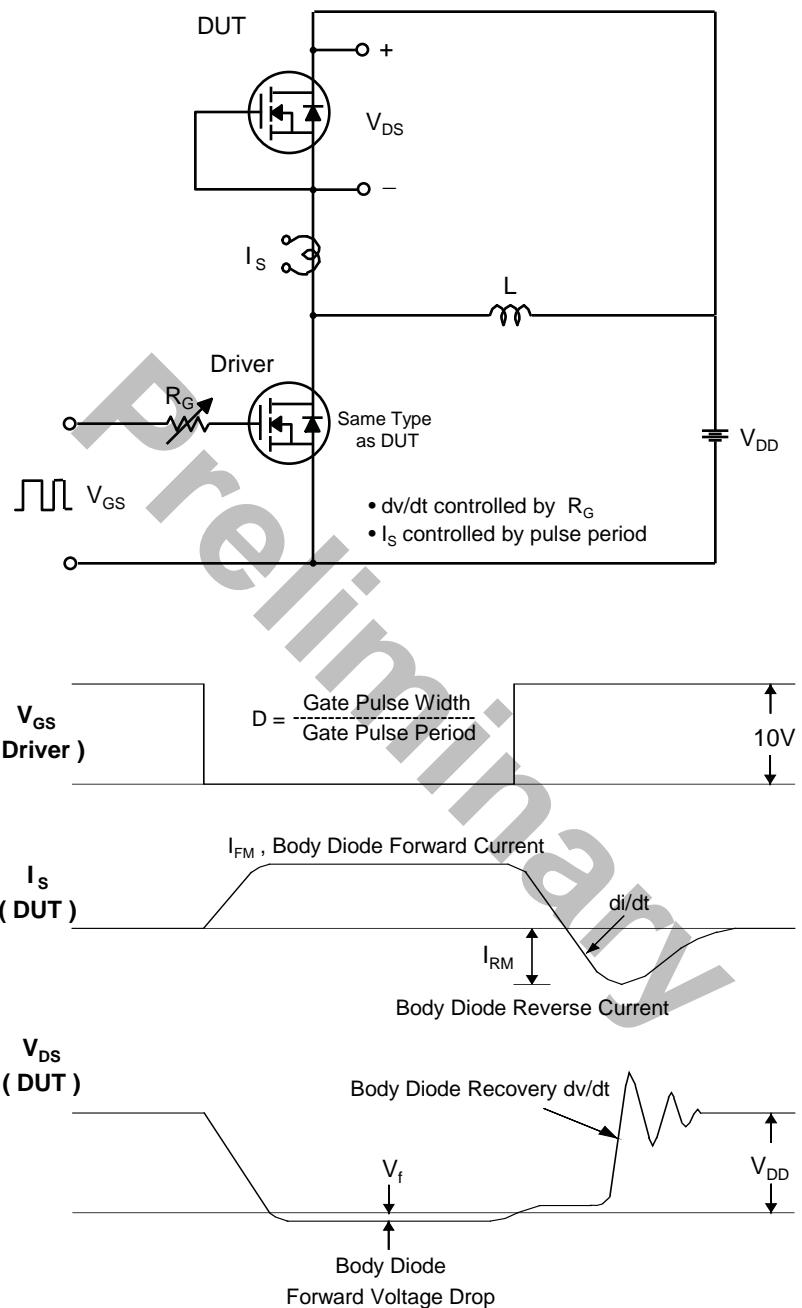


Fig 15. Peak Diode Recovery dv/dt Test Circuit &amp; Waveforms



HRSS88N08K

## Package Dimension

TO-220F

